

# 厦门华联半导体科技有限公司

Xiamen Hualian Semiconductor Technology Co., Ltd.

# 产品规格书 SPECIFICATION

产品名称: 红外遥控接收放大器

**DESCRIPTION: Infrared Module for Remote Control System** 

产品型号: HRM156BB1Y00

PART NO.: HRM156BB1Y00

拟制	审核	批准
Prepared	Verified	Approved

电 话 Tel: 86-0592-2950777

传 真 Fax: 86-0592-6037471

网 址 Web: www.xmhl.com

地 址: 厦门市翔安区舫阳南路 189 号

Add: No.189, Fangyang South Road, Xiang'an District, Xiamen China

#### 1 概述 General

红外遥控接收放大器是将光探测器与前置放大器封装在一起,以实现遥控信号的接收放大。环氧封装可滤除可见光干扰,检波输出信号可直接由微处理器译码。

Infrared module for remote control system which is PIN diode and amplification series are assembled on lead frame, in order to realize the receiving and amplifying the infrared remote controller signal. The type of epoxy package can filter the visual interference. The demodulated output signal can directly be decoded by a microprocessor.



图 1: 产品图片 Figure1 Part photo

#### 2 特点 Features

- 可靠性高 High reliability
- 无外围元件,内部屏蔽 No external parts, Inner discrete shield
- 载波频率 56.7kHz Carrier Frequency 56.7kHz
- 灵敏度高,传输范围远 High sensitivity, Large transmission range
- 对于环境光、电源杂讯和电磁场干扰有很强的抗扰性 High immunity against ambient light, power noise and electromagnetic interference
- 对于 wifi 干扰有很强的抗扰性 High immunity against wifi
- 低功耗 Low power consumption
- 最小脉冲宽度 t<sub>Burst</sub>≥6 载波周期(见图 2) Suitable minimum burst length t<sub>Burst</sub>≥6 cycles of carrier (Figure2)
- 最小脉冲间隔 t<sub>Gap</sub>≥11 载波周期(见图 2) Suitable minimum burst gap time t<sub>Gap</sub>≥11 cycles of carrier (Figure 2)
- 最小信号间隔时间 t<sub>Pause</sub>≥1 毫秒(见图 3)Suitable minimum data pause time t<sub>Pause</sub>≥1ms(Figure3)
- 兼容 TTL&CMOS 电平 TTL&CMOS Compatibility
- 符合 RoHS 指令最新要求及 REACH 法规最新要求 Comply with the latest requirements of the RoHS directive and the latest requirements of REACH regulations.
- 静电防护等级: 防静电等级 2000V (人体模式) ESD grade:2000V (HBM)

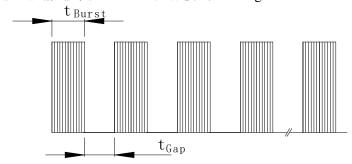


图 2 脉冲宽度和间隔时间

Figure 2 Burst Length and Gap Time

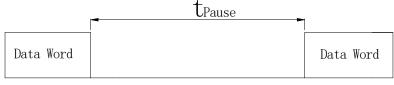


图 3 信号间隔时间 Figure 3 Date Pause Time

#### 3 应用 Applications

主要用于电视机、机顶盒、空调、智能电表、智能扫地机、智能垃极桶、智能电水壶、遥控风扇、灯具等领域。

It may be used in TV sets, STB, air conditioners, Smart Meter, Cleaning Robot, Smart Trash Can, Smart Electric Kettle, Electric Fan lamps and lanterns etc.

PECIFICATION HRM156BB1Y00

#### 4 极限参数 Absolute Maximum Ratings

**从**华联电子

Xiamen Hualian

#### 表 1 极限参数

**Table1 Absolute Maximum Ratings** 

 $T_a=25^{\circ}C$ 

参数	符号	额定值	单位
Parameters	Symbol	Rated Value	Unit
电源电压 Supply Voltage	$V_{CC}$	6.0	V
电源电流 Supply Current	Icc	3.0	mA
输出电压 Output Voltage	Vo	6.0	V
输出电流 Output Current	Io	2.5	mA
工作环境温度 Operating Ambiance Temperature.	$T_{aop}^{b}$	-25~+85	°C
贮存温度 Storage Temp.	$T_{stg}$	-25~+85	°C
功率 Power Dissipation	P	10	mW
焊接温度(5 秒) Soldering Temp.(5s) <sup>a</sup>	$T_{ m sld}$	+260	°C

<sup>&</sup>lt;sup>а</sup> 浸渍入离器件本体 2~2.5 毫米 Dip up to 2.0~2.5mm from the terminal root

#### 5 光电参数 Opto-Electrical Characteristics

#### 表 2 光电参数

#### **Table2Opto-Electrical Characteristics**

 $T_a=25^{\circ}C$ 

参数 Parameters	符号 Symbol	测试条件 Test Condition	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
电源电流	Icc	Vcc=3V Ev=0 Ee=0	0.1	0.25	0.4	mA
Supply Current	100	Vcc=5V Ev=0 Ee=0	0.15	0.3	0.45	ША
峰值波长 Peak Wavelength	$\lambda_{ ext{P}}$		-	940	ı	nm
载波频率 Carrier Frequency	Fc	Internal BPF		56.7		kHz
高电平输出电压 High Output Voltage	V <sub>OH</sub>	Vcc=5V or 3V Ee=2.0mW/ m <sup>2</sup>	Vs-0.3	Vs	-	V
低电平输出电压 Low Output Voltage	V <sub>OL</sub>		-	0.2	0.4	V
低电平输出脉宽 Low output pulse width <sup>c</sup>	TwL	Vcc=5V or 3V IR LED: Ie=200mW/sr; P <sub>W</sub> =600μs Duty=50%	450	600	750	μs
逻辑周期宽度 Logic Period width <sup>c</sup>	Twp		1080	1200	1320	μs
接收距离 Receiving Distance	L	IR LED: Ie=200mW/ sr Vcc=5V or 3V; Ev=0 Lx	20	-	-	m
水平受控角 Horizontal Half Angle	$\theta_{\scriptscriptstyle 1/2}$	IR LED: Ie=200mW/sr; Vcc=5V or 3V;Ev=0 Lx L=10m	-	45	-	deg

b 工作环境温度参数符号只在极限参数表中用 T<sub>aop</sub> 表示,其他地方用 T<sub>a</sub>表示 Parameter symbol of Operating Ambiance Temperature uses T<sub>aop</sub> only in Table 1 Absolute Maximum Ratings,and uses T<sub>a</sub> at other places

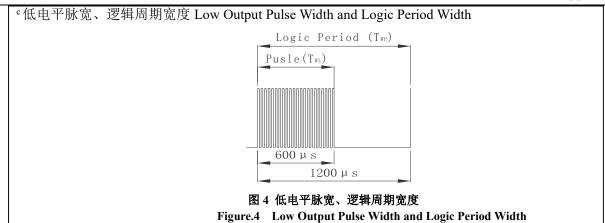


表 3 推荐工作条件

	Tables Rec	ommenaea operating conditions	1a=25°C
参数	符号	工作条件	单位
Parameter	Symbol	Operating conditions	Unit
电源电压 Supply Voltage	Vcc	2.7~5.5	V

#### 6 印章 Mark

在产品背面按如下打印产品型号和生产批号,

Print type model and LOT.NO. on the back of product as follow:

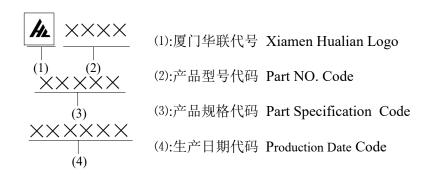


图 5 印章 Figure.5 Mark

# 7 外形尺寸及电原理图 Dimensions and Circuit Diagram

#### ● 内部框图 Block diagram

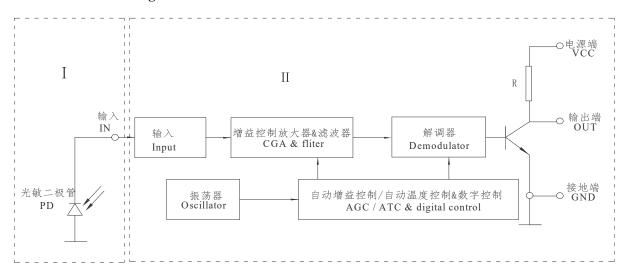


图 6 内部框图 Figure6 Block diagram

# ◆ 结构和材料 Construction & Materials 表 4 结构和材料 Table4 Comstruction & Materials

序号	名称	材料
No.	Name	Material
1	粘合剂 Bond	银胶 Ag Paste
2	支架 Lead Frame	铁材 SPCC
3	塑封料 Molding	环氧材料 Epoxy Resin
4	光敏芯片 Photo diode	硅 Silicon
5	焊线 Bond Wire	金丝 Au Wire
6	IC 芯片 IC chip	硅 Silicon

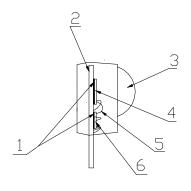


图 7 结构和材料
Figure7 Construction&Materials

● 外形图 Outline(单位 Unit: 毫米 mm)

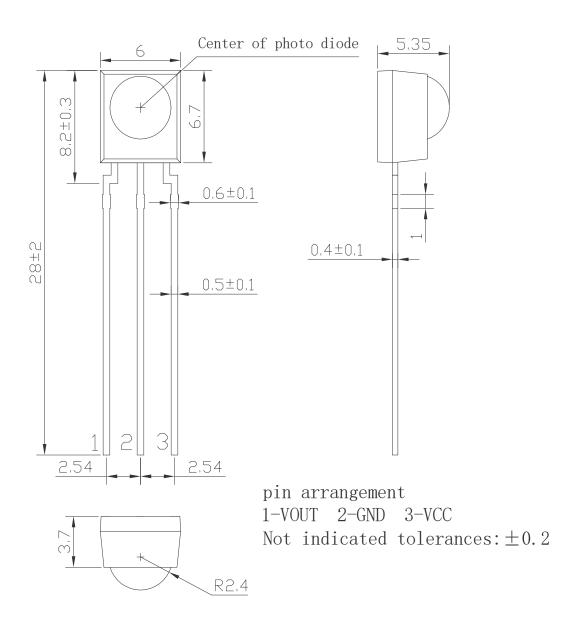
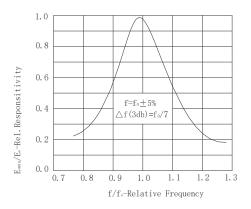


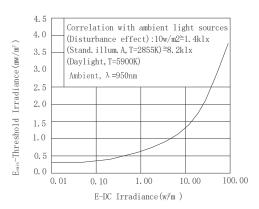
图 8 外形尺寸 Figure 8 Dimension



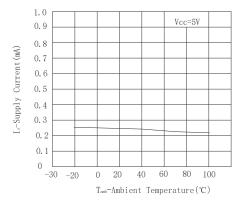
#### 8 特性曲线 Characteristics Curve



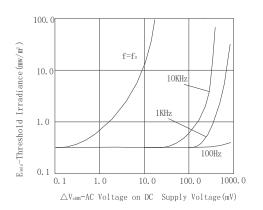
a) Frequency Dependence of Responsivity



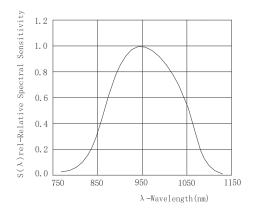
c) Sensitivity in Bright Ambient



e) Supply Current vs. Ambient Temperature



b) Sensitivity vs. SupplyVoltage Disturbances



d) Relative Spectral Sensitivity vs.Wavelength 10° 30° 1.0 0.9 40° 0.8 45° 50° 0.7 60° 70° 80° 0.4 0.6 d<sub>rel</sub>-Relative Transmission Distance

f) Directivity

图 9 特性曲线 Figure 9 Characteristics Curve

# 9 可靠性试验要求 Reliability Test

### 表 5 可靠性试验要求 Table 5 Reliability Test

组别 No.	试验项目 Test Item	试验样品 Sample Number	试验条件 Test Conditions	指标 Request	[Ac, Re]
	引出端拉力   Terminal Pull   16   外加力: 10N Pull: 10N   时间: 10 秒 Time: 10s   引出端弯曲   强度   外加力: 2.5N 0°~90°~0° 弯曲 2 次。   Pull: 2.5N 0°~90°~0°Bend 2 times.		无损坏 No Damage	[0, 1]	
1			无损坏 No Damage	[0, 1]	
	可焊性 Solder Ability	16	温度: (245±5) ℃ Temperature: (245±5) ℃. 时间: (2±0.5) 秒 浸入离器件本体 (1.0~1.2) mm。 Times:(2±0.5)s Dip up to 1.0~1.2mm from the terminal root. 焊剂: 无铅焊锡 Sn(95% ~ 96.5%)/Ag(3% ~ 4%)/Cu(0.5%~1.0%) Flux: No Pb soldering Sn(95% ~ 96.5%)/Ag(3%~4%)/Cu(0.5%~1.0%). 助焊剂: 松香 25%,酒精 75%。 Help Flux: 75% isopropyl alcohol, 25% resin.	浸润面积≥ 浸渍面积的 95% Soakage Area≥95 percent of dip area.	[0, 1]
2	耐焊接热 Thermal Weld	16	波峰焊: 焊锡温度( $260\pm5$ ) $^{\circ}$ 、浸渍时间( $10\pm1$ )秒,浸渍到离器件本体( $2^{\circ}2.5$ )mm,焊剂: 无铅焊锡 Sn( $95\%\sim96.5\%$ )/Ag( $3\%\sim4\%$ )/Cu( $0.5\%\sim1.0\%$ ), 助焊剂: 松香 $25\%$ ,酒精 $75\%$ 。 Wave soldering: Temperature: ( $260\pm5$ ) $^{\circ}$ C,Immersed for ( $10\pm1$ )sec.( $2.0\sim2.5$ )mm away from the body. Flux: No Pb soldering: Sn( $95\%\sim96.5\%$ )/Ag( $3\%\sim4\%$ )/Cu( $0.5\%\sim1.0\%$ ). Help Flux: 75% isopropyl alcohol, 25% resin.		[0, 1]
			焊剂: 无铅 4%)/Cu(0.5%~ Soldering iror iron:(350±5)℃; soldering: Sn(95	烙铁焊: 焊锡温度(350±5)℃, 浸渍时间(10±1)秒, 焊剂: 无铅焊锡 Sn(95% ~ 96.5%)/Ag(3% ~ 4%)/Cu(0.5%~1.0%), 助焊剂: 松香 25%, 酒精 75%。 Soldering iron: Temperature head of soldering iron:(350±5)℃; soldering time:(10±1) sec; Flux: No Pb soldering: Sn(95%~96.5%)/Ag(3%~4%)/Cu(0.5%~1.0%). Help Flux: 75% isopropyl alcohol, 25% resin.	试验完成后, 试验样品在 标准大气条 件下恢复4h 后,在4h内 测试光电参
3	快速温度变 化及交变湿 热 Temperature Fast Changing and Heat Humidity Cycling	大速温度变 と及交変湿 热 TA= $(-25\pm2)$ $\mathbb C$ , TB= $(85\pm2)$ $\mathbb C$ , 暴露时间: $10$ 分钟, 转移时间: $(2-3)$ 分钟,循环次数: $5$ 次,恢复时间 $2h$ 后继之于循环湿热,试验严酷度: $T=(55\pm2)$ $\mathbb C$ ,湿度: $(90^\circ 95)$ %;循环次数: $2$ 次 TA= $(-25\pm2)$ $\mathbb C$ , TB= $(85\pm2)$ $\mathbb C$ , Exposure Time: $10$ mins; Transferring Time: $2\sim3$ mins; Cycle times: $5$ Cycles; Following the Heat Humidity Cycling after renew $2$ hours: asperity degree: $T=(55\pm2)$ $\mathbb C$ , humidity: $(90\sim95)$ %, $2$ Cycles. 上耐久试验  E耐久试验		数应符合表 2 的规定。 Finish a test of optoelectroni cs characteristic s within four hours after renew four hours.	[0, 1]
4					[0, 1]
5	高温贮存 High Temperature Storage	16	温度:(85±2)℃,时间: 1000 小时。 T: (85±2)℃, t: 1000h.		[0, 1]
Ü	低温贮存 Low 16 Temperature Storage		温度:(-25±2)℃,时间: 168 小时。 T: (-25±2)℃, t: 168h.		[0, 1]

2023-01-10

(本规格书用于技术交流用,经签章方生效)

Page 8 of 14

Ver 1.0

# 10 包装方式 Packing

包装采用防静电袋和外包装纸箱,外包装箱上应有符合 GB191 中规定的相应运输要求的标志以及标明公司名称、商标、地址、产品名称、型号、数量等,并贴有封讫,箱内应有合格证,标明型号、生产日期及检验员代号等。

The parts are put into antistatic plastic bag which are packed in cartons. On the carton, followings are printed: mark of transportation stipulated in GB191, Company Name, Trade mark, Address, Product Description, Model and Quantity. Sealing mark is stuck on the carton too. Inside the carton there are qualification certificate, stated model, production date and inspector's code.

10.1 内包装用防静电袋包装,300 只/包。

Internally packed with antistatic bag, 300pcs/bag.

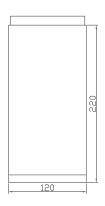


图 10 内包装袋 Figure 10 Internally bag

10.2 内包装用纸箱 275mm×220mm×83mm, 4500 只/箱。

Internally packed with 275mm×220mm×83mm, 4500 pcs/carton.

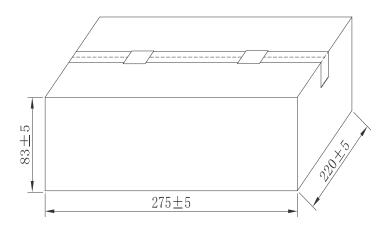


图 11 内包装箱 Figure 11 Internally cartons

10.3 外包装用纸箱 455mm×285mm×185mm, 18000 只/箱。

Externally packed with 455mm×285mm×185mm cartons, 18000 pcs/carton.

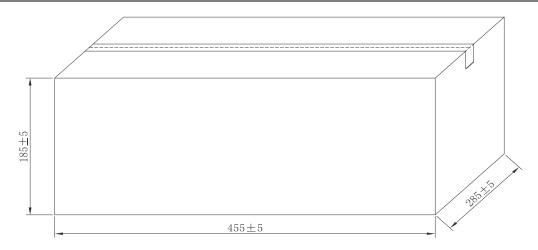


图 12 外包装箱 Figure 12 Externally cartons

10.4 标识 Label。

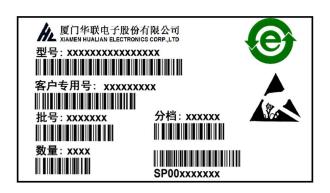


图 13 标识 Figure 13 Label

#### 11 使用注意事项 Precautions for Use

**11.1** 该产品为静电敏感元件,要求使用时人和所有的装置(包括烙铁)、设备、机器、桌子、地面等都必须 采取防静电措施。

Since the device is static sensitive, it is requested that anti-static measures should be taken on human body and all devices (including soldering iron) and equipment, machinery, desk and ground.

- 11.2 不要对引脚施加不必要的外力。Do not apply unnecessary stress to lead.
- 11.3 注意保护接收器的接收面,沾污后会影响接收性能,同时不要触碰接收表面。

Please pay attention to the lens of receivers, It might affect the performance if it gets dirty, don't touch the receiving surface either.

- 11.4 在外部电路上必须加上限流电阻,避免出现浪涌电流对器件造成破坏。
  - Current limited resistor should be added to the peripheral circuit to avoid shock of powerful current.
- 11.5 适合的红外编码格式: NEC、RC5、RC6、RCA、RCMM、XMP、R-step、Sharp;

Suitable IR data format: NEC, RC5, RC6, RCA, RCMM, XMP, R-step, Sharp;

11.6 红外遥控接收放大器的解码性能,包括对遥控器的发射信号正确解码以及解码的质量(输出脉宽和周期的宽度,干扰信号输出等)均受应用条件(红外编码格式,发射信号强度、负载及滤波等外围电路、干扰、软件设定等)因素的影响。如果这些应用条件变化,红外遥控接收放大器有可能输出不正确的信

号,将会导致设备不能遥控,或遥控不灵敏。因此每一个机型在批量使用红外遥控接收放大器前,都必 须在所用的机型上进行样品和小批量产品的验证。

The performance of IR receiver's demodulated output signal, which decode the controller's signal correctly and the quality of the output signal (such as the width of output pulse and period, output interference signal, etc), has close relations with the conditions of application (IR code, the radiation intensity of controller, external circuit about load and filter, interference, the setting of soft program about demodulated IR code, etc). If the conditions of application have been changed, the IR receiver maybe output signal incorrectly. It will lead to the equipment has not been controlled or does not respond to the control every time. So the customer must to test and verify the samples and a little batch of product in every model of equipment before the large batch of product to be used.

11.7 在不同工作电压下,产品的解码性能,包括对遥控器的发射信号正确解码以及解码的质量(输出脉宽和周期的宽度,干扰信号输出等)能否正常解码及其解码质量(改变脉宽宽度,有干扰信号等)会有所差异。当工作电压变化到一定程度时,红外遥控接收放大器有可能输出不正确的信号,将会导致设备不能遥控,或遥控不灵敏。因此在工作电压非 5V 或 3V 时,每一个机型在批量使用红外遥控接收放大器前,都必须在所用的机型上进行样品和小批量产品的验证。

The performance of IR receiver's demodulated output signal, which decode the controller's signal correctly and the quality of the output signal (such as the width of output pulse and period, output interference signal, etc) differ from varied supply voltage. When the supply voltage has been changed, the IR receiver maybe output signal incorrectly. It will lead to the equipment has not been controlled or does not respond to the control every time. When the supply voltage isn't 5V or 3V, the customer must to test and verify the samples and a little batch of product in every model of equipment before the large batch of product to be used.

#### 11.8 推荐电路 Recommended circuit

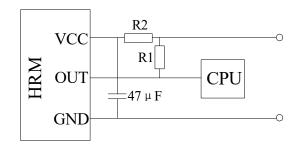


图 14 推荐电路 Figure 14 Recommended Circuit

Note: 1、推荐外部上拉电阻 R1 为 10kΩ。10kΩ for external pull-up resister (R1) is recommended.

- 2、限流电阻 R2 推荐使用 100Ω。100Ω for current limited resistor (R2) is recommended.
- 3、R1 and R2 可以根据实际电路调整。R1 and R2 shall be adjusted after considering the real condition.
- 11.9 推荐焊接条件 Recommended soldering conditions
- 11.9.1 施加在环氧树脂上的温度不要超过最高贮存温度。

Not to apply high temperature exceeding the maximum storage temperature to the epoxy resin.

11.9.2 在高温下不要对环氧树脂施加压力

Not to apply any force to the epoxy resin at high temperature.

- 11.9.3 焊接过程 Soldering process
- (1)元器件的焊盘焊接区的插孔间距必须一致,以避免在焊接过程中出现应力,这会导致器件开路。并且必须在焊接前进行器件引脚成形,引脚成形过程中不要对环氧体内部施加压力。

2023-01-10

#### 规格书 SPECIFICATION

HRM156BB1Y00

The distance between holes should be the same as that of between terminal lands of the component to avoid any stress during the soldering process. This may lead to the open circuit. Also, lead forming should be done before soldering process not to apply any stress to the inside of the epoxy resin.

(2)在焊接过程中不要对器件施加任何压力

Not to apply any stress to the component during the soldering process.

(3)推荐焊接条件Recommended soldering condition

表6 推荐焊接条件 Table6 Recommended soldering condition

	条件Condition		
波峰焊	预热: 小于120度 Pro-heating: less than 120℃		
预热温度和焊锡槽温度	焊锡槽温度: 260度 Solder bath:260℃		
Wave soldering	浸渍入离器件环氧体底部3毫米;浸渍时间:6±1s;次数小于2次		
Pro-heating &solder bath	Soldering area: 3mm away from the bottom the epoxy resin.		
	Dip time: $6\pm 1$ seconds, less than twice.		
烙铁焊接	烙铁温度小于350度,次数2次,每次时间3秒		
Soldering iron	Temperature: Less than 350°C, within 3 seconds, 2 times		
	烙铁离环氧体底部3毫米		
	Soldering area: 3mm away from the bottom of the epoxy resin.		

#### 11.10 清洗 washing

一些化学试剂会破坏环氧树脂

Some chemicals may damage the epoxy resin.

推荐按下列条件使用乙醇清洗

Ethyl alcohol is recommended under the following condition.

表7 推荐清洗条件 Table 7 Recommended washing condition

· PC - 3 pc 13	1110034111 Impre : Iteeommenaea : maning constraint	
	温度小于45度	
化学清洗	Temperature: less than 45 °C	
Chemical washing	清洗时间小于3分钟	
	Wash time: less than 3 minutes.	
	功率小于15 W/L	
超声波清洗	Power: less than 15W/L	
Ultrasound washing	清洗时间小于3分钟	
	Wash time: Less than 3 minutes	

#### 12 申明 Statement

**12.1** 后续由于提高产品的可靠性、功能或者是设计引起的所有产品的规格以及产品的数据资料更改将不再做另行通知。

All product, product specification and data may be changed without notice to improve reliability, Function or design.

**12.2** 规格书所述只是针对于规格书上所列的产品,产品在常规运用上的性能优良,比如机顶盒,电视机,空调等,无法保证产品在特殊运用上的可行性。

The datasheet is only suitable for the product showed in the specification. The product show well performance on common such as set-box, television, air conditioners ,etc. HuaLian makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose.



#### 规格书 SPECIFICATION

HRM156BB1Y00

12.3 为最大程度上遵守法律法规,华联对产品应用引起的法律责任不做负责。

To the maximum extent permitted by applicable law, HuaLian disclaims any and all liability arising out of the application or use of any product.

12.4 华联的产品不设计为医疗, 急救, 或是其他有可能由于失效而引起伤害或者是生命危险的运用。

Hualian products are not designed for use in medical, life-saving, or life-sustaining, applications or for any other application in which the failure of the Vishay product could result in personal injury or death.



# 更改记录表

#### **Engineering Change Notice-Record**

版次 EDITION	更改日期 DATE	主要更改内容 MAIN CONTENT	拟 制 PREPARED	确 认 CHECKED
1.0	2023-01-10	新版发行 New edition		